

## **GaAs INTEGRATED CIRCUIT**

# $\mu$ PG2164T5N

#### DPDT SWITCH FOR 2.4 GHz AND 6 GHz DUAL-BAND WIRELESS LAN

#### **DESCRIPTION**

The  $\mu$ PG2164T5N is a GaAs MMIC DPDT ( $\underline{D}$ ouble  $\underline{P}$ ole  $\underline{D}$ ouble  $\underline{T}$ hrow) switch which was developed for 2.4 GHz and 6 GHz dual-band wireless LAN. This device can operate frequency from 2.4 GHz band and 6 GHz band, having the low insertion loss and high isolation.

This device is housed in a 6-pin plastic TSON (Thin Small Out-line Non-leaded) package. And this package is able to high-density surface mounting.

#### **FEATURES**

Operating frequency : f = 2.4 to 2.5 GHz and 4.9 to 6.0 GHz
 Switch control voltage : V<sub>cont (H)</sub> = 2.8 to 5.0 V (3.0 V TYP.)

:  $V_{cont(L)} = -0.3 \text{ to } 0.3 \text{ V (0 V TYP.)}$ 

Low insertion loss
 : Lins1 = 0.50 dB TYP. @ f = 2.4 to 2.5 GHz, Vcont (H) = 3.0 V, Vcont (L) = 0 V

: Lins2 = 0.70 dB TYP. @ f = 4.9 to 6.0 GHz,  $V_{cont (H)}$  = 3.0 V,  $V_{cont (L)}$  = 0 V

• High isolation : ISL1 = 25 dB TYP. @ f = 2.4 to 2.5 GHz,  $V_{cont(H)} = 3.0$  V,  $V_{cont(L)} = 0$  V

: ISL2 = 17 dB TYP. @ f = 4.9 to 6.0 GHz,  $V_{cont(H)}$  = 3.0 V,  $V_{cont(L)}$  = 0 V

• Handling power :  $P_{in (1 dB)} = +31.0 dBm TYP$ . @ f = 2.5 GHz,  $V_{cont (H)} = 3.0 V$ ,  $V_{cont (L)} = 0 V$ 

: Pin (1 dB) = +29.0 dBm TYP. @ f = 6.0 GHz,  $V_{cont(H)}$  = 3.0 V,  $V_{cont(L)}$  = 0 V

High-density surface mounting: 6-pin plastic TSON package (1.5 × 1.5 × 0.37 mm)

#### **APPLICATION**

• Dual-band wireless LAN (IEEE802.11a + b/g)

#### **ORDERING INFORMATION**

Part Number	Order Number	Package	Marking	Supplying Form
μPG2164T5N-E2	μPG2164T5N-E2-A	6-pin plastic TSON (Pb-Free)	G5B	<ul> <li>Embossed tape 8 mm wide</li> <li>Pin 1, 6 face the perforation side of the tape</li> <li>Qty 3 kpcs/reel</li> </ul>

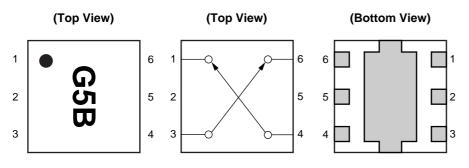
**Remark** To order evaluation samples, contact your nearby sales office.

Part number for sample order:  $\mu$ PG2164T5N-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

## PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name	
1	ANT2	
2	V <sub>cont</sub> 2	
3	OUT2 (RX)	
4	OUT1 (TX)	
5	V <sub>cont</sub> 1	
6	ANT1	

Remark Exposed pad : GND

#### TRUTH TABLE

V <sub>cont</sub> 1	V <sub>cont</sub> 2	ANT1-OUT1 (TX)	ANT1- OUT2 (RX)	ANT2- OUT1 (TX)	ANT2-OUT2 (RX)
High	Low	OFF	ON	ON	OFF
Low	High	ON	OFF	OFF	ON

## ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	V <sub>cont</sub>	-6.0 to +6.0	V
Input Power	Pin	+32	dBm
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	T <sub>stg</sub>	-55 to +135	°C

## RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Control Voltage (H)	V <sub>cont</sub> (H)	2.8	3.0	5.0	V
Switch Control Voltage (L)	V <sub>cont</sub> (L)	-0.3	0	0.3	V
Operating Frequency 1	f1	2.4	I	2.5	GHz
Operating Frequency 2	f2	4.9	=	6.0	GHz

#### **ELECTRICAL CHARACTERISTICS**

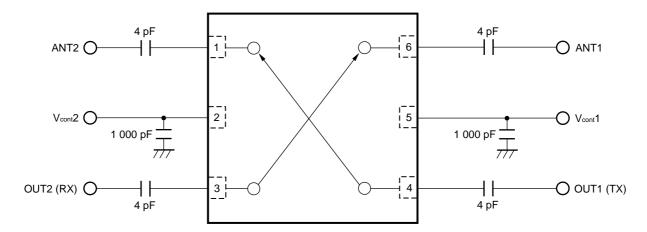
(TA = +25°C,  $V_{cont}$  (H) = 3.0 V,  $V_{cont}$  (L) = 0 V,  $Z_0$  = 50  $\Omega$ , DC blocking capacitors = 4 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 2.4 to 2.5 GHz	-	0.50	0.75	dB
Insertion Loss 2	Lins2	f = 4.9 to 6.0 GHz	-	0.70	1.00	dB
Isolation 1 (ANT to OUT)	ISL1	f = 2.4 to 2.5 GHz	22	25	-	dB
Isolation 2 (ANT to OUT)	ISL2	f = 4.9 to 6.0 GHz	14	17	-	dB
Isolation 3 (ANT1 to ANT2, TX to RX)	ISL3	f = 2.4 to 2.5 GHz	22	25	I	dB
Isolation 4 (ANT1 to ANT2, TX to RX)	ISL4	f = 4.9 to 6.0 GHz	15	17	I	dB
Input Return Loss 1	RLin1	f = 2.4 to 2.5 GHz	-	15	-	dB
Input Return Loss 2	RLin2	f = 4.9 to 6.0 GHz	-	15	-	dB
Output Return Loss 1	RLout1	f = 2.4 to 2.5 GHz	-	15	-	dB
Output Return Loss 2	RLout2	f = 4.9 to 6.0 GHz	1	15	ı	dB
1 dB Loss Compression Input Power 1 Note	Pin (1 dB) 1	f = 2.4 to 2.5 GHz	-	+31.0	-	dBm
1 dB Loss Compression Input Power 2 Note	Pin (1 dB) 2	f = 4.9 to 6.0 GHz	=	+29.0	=	dBm
Input 3rd Order Distortion Intercept Point	IIP3	f1 = 2 500 MHz, f2 = 2 501 MHz, Pin (1 tone) = +20 dBm	=	+50	-	dBm
Switch Control Current	Icont			0.1	1.0	μА
Switch Control Speed	tsw	50% CTL to 90/10%	-	50	ı	ns

**Note** Pin (1 dB) is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC blocking capacitors.

#### **EVALUATION CIRCUIT**

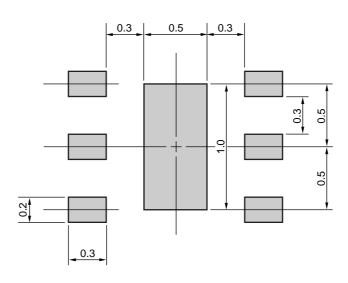


The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

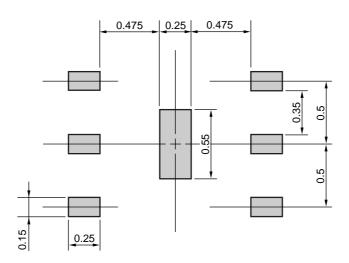
#### MOUNTING PAD AND SOLDER MASK LAYOUT DIMENSIONS

## 6-PIN PLASTIC TSON (UNIT: mm)

#### **MOUNTING PAD**



#### **SOLDER PAD**

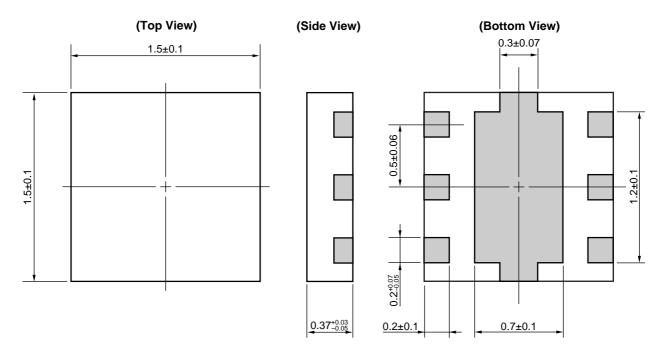


Solder thickness: 0.08 mm

**Remark** The mounting pad layouts in this document are for reference only.

#### **PACKAGE DIMENSIONS**

## 6-PIN PLASTIC TSON (UNIT: mm)



#### RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).



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CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (\*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration in CEL	on contained devices
Lead (Pb)	< 1000 PPM	-A -AZ Not Detected (*)	
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

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